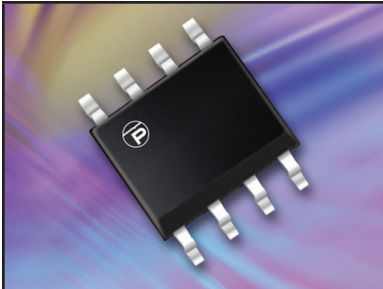


500 WATT MULTI-LINE LOW CAPACITANCE TVS ARRAY



SO-8 PACKAGE

DESCRIPTION

The SMDAxxLC and SMDAxxLCC Series are low capacitance multi-line transient voltage suppressor arrays that provides board level protection for standard TTL and MOS bus line applications against the damaging effects of ESD, tertiary lightning and switching transients.

The SMDAxxLC/LCC Series has a peak pulse power rating of 500 Watts for an 8/20 μ s waveshape. This device series meets the IEC 61000-4-2, IEC 61000-4-4 and IEC 61000-4-5 requirements.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A - 5/50ns
- Compatible with IEC 61000-4-5 (Surge): 12A, 8/20 μ s - Level 1(Line-Gnd) & Level 2(Line-Line)
- 500 Watts Peak Pulse Power per Line (tp = 8/20 μ s)
- Unidirectional and Bidirectional Configurations
- Available in Multiple Voltages Ranging from 3V to 24V
- Protects up to Four Lines
- Low Capacitance: 15pF
- RoHS Compliant
- REACH Compliant

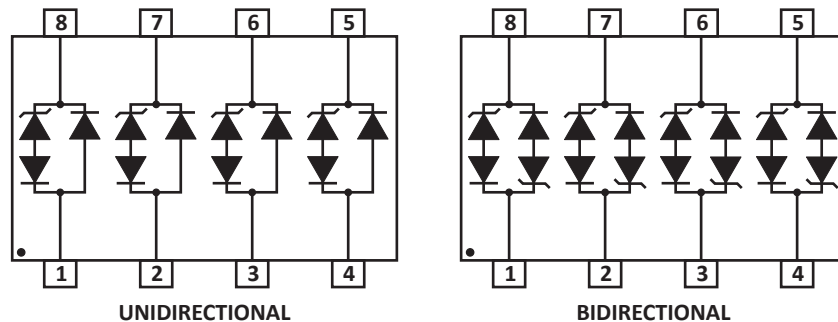
APPLICATIONS

- Computer Interface Protection
- Ethernet - 10/100/1000 Base T
- Test and Measurement Equipment
- Industrial Control - Low Voltage Sensors

MECHANICAL CHARACTERISTICS

- Molded JEDEC SO-8 Package
- Approximate Weight: 70 milligrams
- Lead-Free Pure-Tin Plating (Annealed)
- Solder Reflow Temperature:
Pure-Tin - Sn, 100: 260-270°C
- 12mm Tape and Reel Per EIA Standard 481
- Flammability Rating UL 94V-0

PIN CONFIGURATIONS



TYPICAL DEVICE CHARACTERISTICS
MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Operating Temperature	T_L	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C
Peak Pulse Power (tp = 8/20µs) - See Figure 1	P_{PP}	500	Watts
Forward Voltage @ 50mA, 300µs - Square Wave (See Note 1)	V_F	1.5	Volts

NOTE
1. Only applies to unidirectional devices.

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

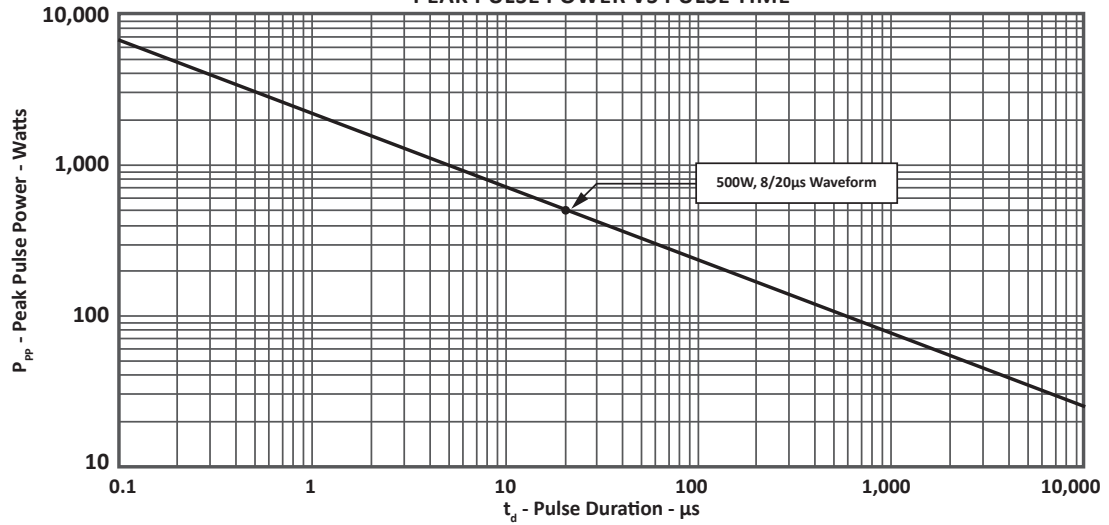
PART NUMBER (Note 1)	DEVICE MARKING	RATED STAND-OFF VOLTAGE	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (Fig. 2)	MAXIMUM CLAMPING VOLTAGE (Fig. 2)	MAXIMUM LEAKAGE CURRENT	MAXIMUM CAPACITANCE
		V_{WM} VOLTS	@1mA $V_{(BR)}$ VOLTS	@ $I_p = 1A$ V_C VOLTS	@ 8/20µs $V_C @ I_{PP}$ VOLTS	@ V_{WM} I_D µA	@0V, 1MHz C pF
SMDA03LC	SLA	3.3	4.5	7.0	10.9V @ 43.0A	125	15
SMDA03LCC	SLB	3.3	4.5	7.0	10.9V @ 43.0A	125	15
SMDA05LC	SLC	5.0	6.0	9.8	13.5V @ 42.0A	20	15
SMDA05LCC	SLD	5.0	6.0	9.8	13.5V @ 42.0A	20	15
SMDA08LC	SLE	8.0	8.5	13.4	16.9V @ 34.0A	10	15
SMDA08LCC	SLF	8.0	8.5	13.4	16.9V @ 34.0A	10	15
SMDA12LC	SLG	12.0	13.3	19.0	25.9V @ 27.0A	1	15
SMDA12LCC	SLH	12.0	13.3	19.0	25.9V @ 27.0A	1	15
SMDA15LC	SLJ	15.0	16.7	24.0	30.0V @ 17.0A	1	15
SMDA15LCC	SLK	15.0	16.7	24.0	30.0V @ 17.0A	1	15
SMDA24LC	SLL	24.0	26.7	43.0	49.0V @ 12.0A	1	15
SMDA24LCC	SLM	24.0	26.7	43.0	49.0V @ 12.0A	1	15

NOTES

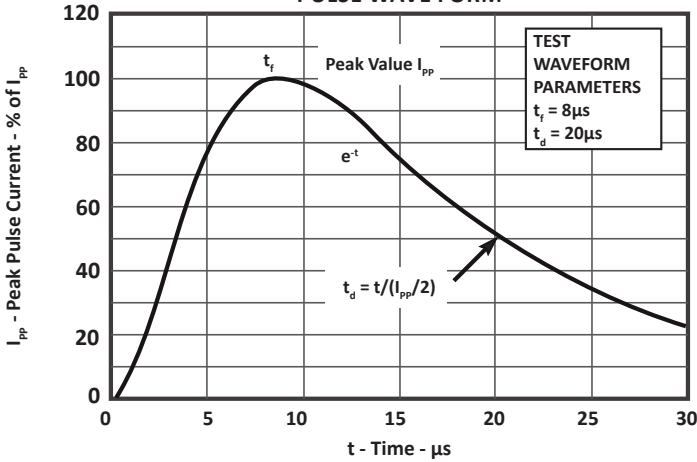
1. Part numbers with a "C" suffix are bidirectional devices, i.e., SMDA03LCC.

TYPICAL DEVICE CHARACTERISTICS

**FIGURE 1
PEAK PULSE POWER VS PULSE TIME**

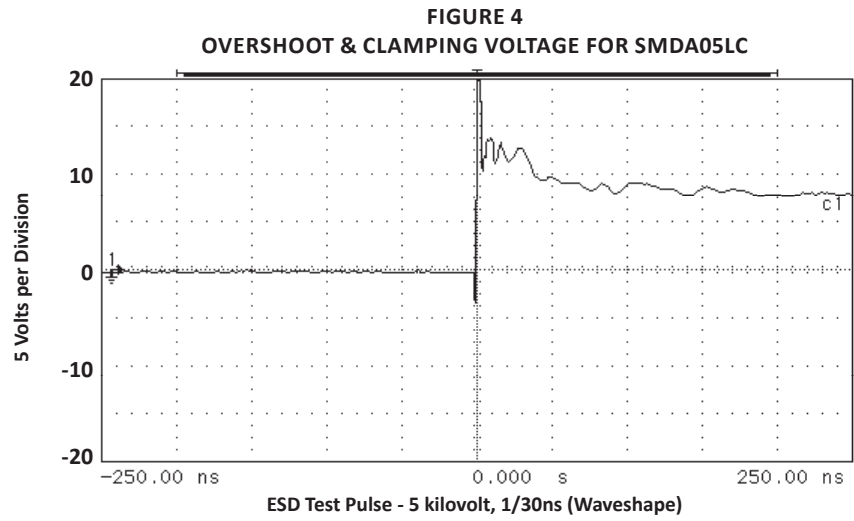


**FIGURE 2
PULSE WAVE FORM**

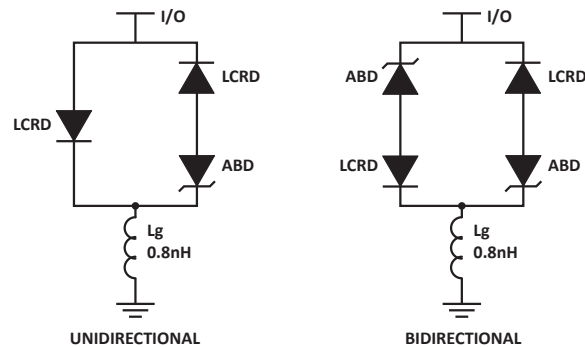


**FIGURE 3
POWER DERATING CURVE**



TYPICAL DEVICE CHARACTERISTICS

SPICE MODEL

FIGURE 1
SPICE MODEL


ABD - Avalanche Breakdown Diode (TVS)
 LCRD: Low Capacitance Rectifier Diode
 Lg - Lead Inductance

TABLE 1 - SPICE PARAMETERS

PARAMETER	UNIT	ABD(TVS)	LCRD
BV	V	See Table 2	200
IBV	μA	1	0.01
C _{jo}	pF	See Table 2	5
I _s	A	See Table 2	1E-13
Vj	V	0.6	0.6
M	-	0.33	0.33
N	-	1	1
R _s	Ohms	See Table 2	0.31
TT	s	1E-8	1E-9
EG	eV	1.11	1.11

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS

PART NUMBER	B _v (VOLTS)	C _{jo} (pF)	I _s (AMPS)	Rs(OHMS)
SMDA03LC	4.5	438	1E-11	0.21
SMDA05LC	6.0	284	1E-11	0.14
SMDA08LC	8.5	146	1E-11	0.28
SMDA12LC	13.3	123	1E-13	0.40
SMDA15LC	16.7	102	1E-13	0.52
SMDA24LC	26.7	61	1E-13	1.54
SMDA03LCC	4.5	438	1E-11	0.21
SMDA05LCC	6.0	284	1E-11	0.14
SMDA08LCC	8.5	146	1E-11	0.28
SMDA12LCC	13.3	123	1E-13	0.40
SMDA15LCC	16.7	102	1E-13	0.52
SMDA24LCC	26.7	61	1E-13	1.54

APPLICATION INFORMATION

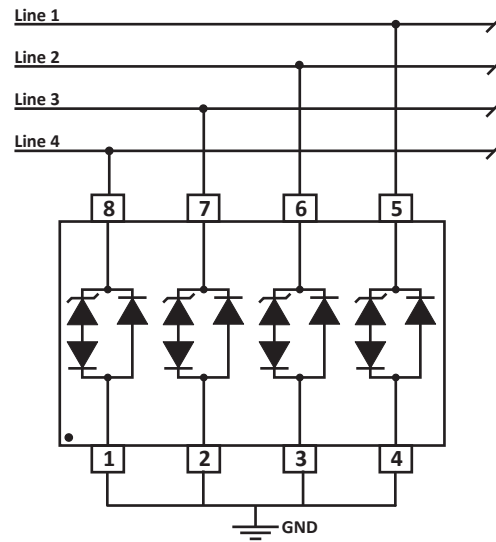


FIGURE 1 - UNIDIRECTIONAL COMMON-MODE PROTECTION

Circuit connectivity is as follows:

- Line 1 connected to Pin 5.
- Line 2 connected to Pin 6.
- Line 3 connected to Pin 7.
- Line 4 connected to Pin 8.
- Pins 1 - 4 connected to ground.

APPLICATION INFORMATION

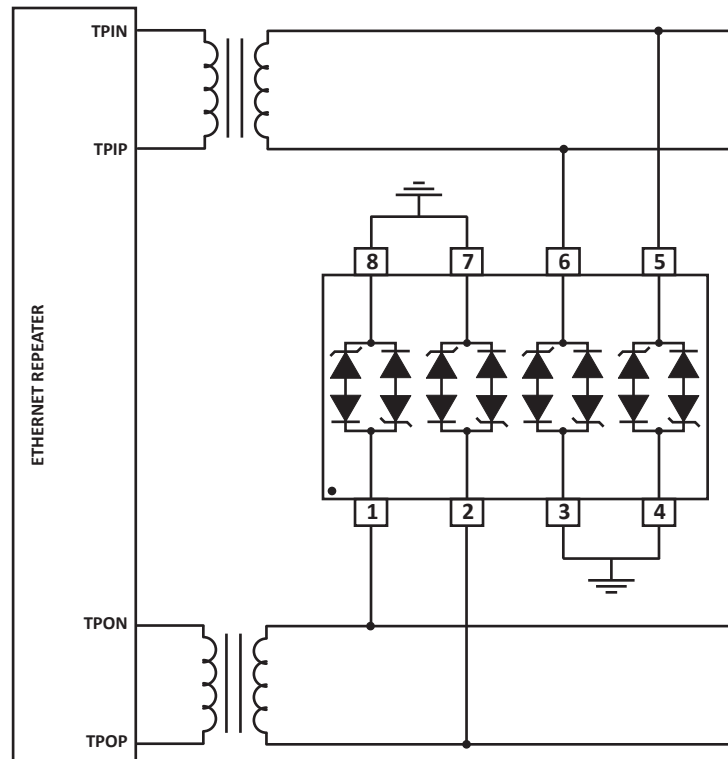


FIGURE 2 - BIDIRECTIONAL COMMON-MODE ETHERNET PROTECTION

Circuit connectivity is as follow:

- TPIN connected to Pin 5.
- TPIP connected to Pin 6.
- TPON connected to Pin 1.
- TPOP connected to Pin 2.
- Pins 3, 4, 7 and 8 connected to ground.

CIRCUIT BOARD RECOMMENDATIONS

Circuit board layout is critical for electromagnetic compatibility protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

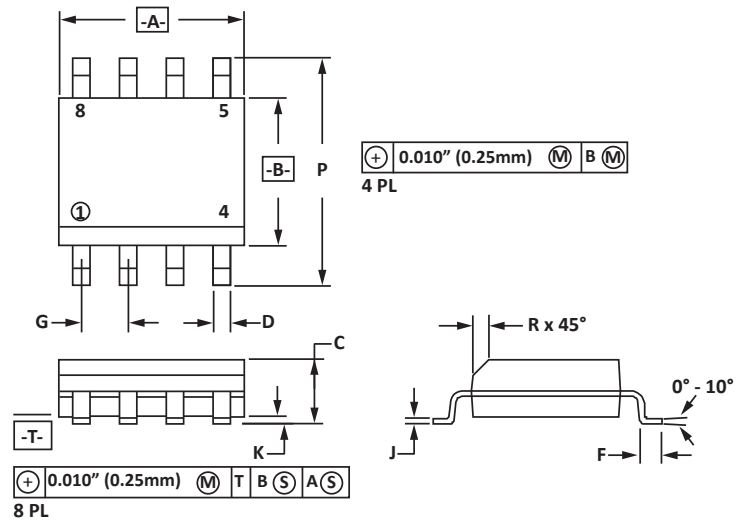
SO-8 PACKAGE INFORMATION

OUTLINE DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.196
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.05 BSC	
J	0.18	0.25	0.007	0.009
K	0.10	0.25	0.004	0.008
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

NOTES

- T = Seating plane and datum surface.
- Dimensions "A" and "B" are datum.
- Dimensions "A" and "B" do not include mold protrusion.
- Maximum mold protrusion is 0.015" (0.380mm) per side.
- Dimensioning and tolerances per ANSI Y14.5M, 1982.
- Dimensions are exclusive of mold flash and metal burrs.

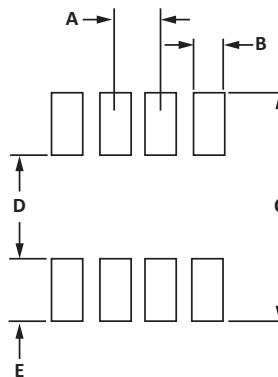


PAD LAYOUT DIMENSIONS

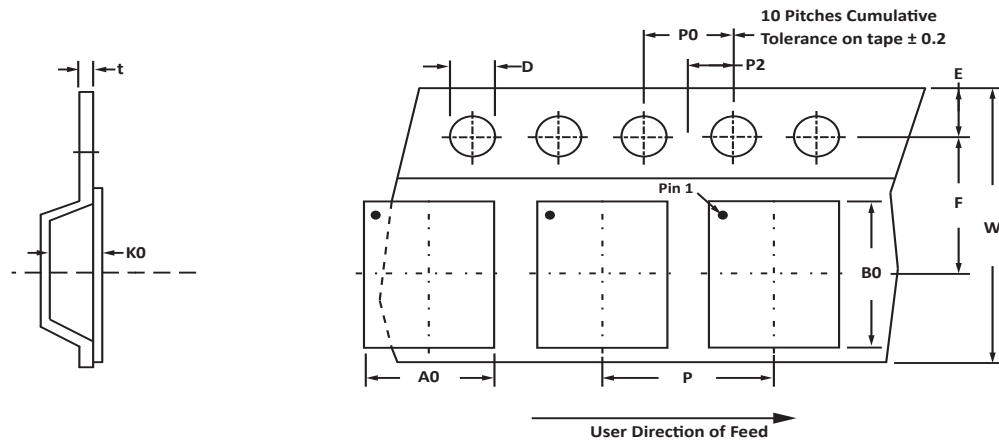
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.14	1.40	0.045	0.055
B	0.64	0.89	0.025	0.035
C	6.22	-	0.245	-
D	3.94	4.17	0.155	0.165
E	1.02	1.27	0.040	0.050

NOTES

- Controlling dimension: inches.



TAPE AND REEL



SPECIFICATIONS

REEL DIA.	TAPE WIDTH	A0	B0	K0	D	E	F	W	P0	P2	P	tmax
178mm (7")	12mm	6.50 ± 0.10	5.40 ± 0.10	2.00 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	5.50 ± 0.05	12.00 ± 0.30	4.00 ± 0.12	2.00 ± 0.10	4.00 ± 0.10	0.25

NOTES

1. Dimensions are in millimeters.
2. Surface mount product is taped and reeled in accordance with EIA-481.
3. Suffix - T7 = 7" Reel - 1,000 pieces per 12mm tape.
4. Suffix - T13 = 13" Reel - 2,500 pieces per 12mm tape.
5. Bulk product shipped in tubes of 98 pieces per tube.
6. Marking on Part - marking code (see page 2), date code, logo and pin one defined by dot on top of package.

Package outline, pad layout and tape specifications per document number 06011.R4 8/10.

ORDERING INFORMATION

BASE PART NUMBER (xx = Voltage)	LEADFREE SUFFIX	TAPE SUFFIX	QTY/REEL	REEL SIZE	TUBE QTY
SMDAxx/SMDAxxC	-LF	-T7	1,000	7"	98
SMDAxx/SMDAxxC	-LF	-T13	2,500	13"	98

COMPANY INFORMATION

COMPANY PROFILE

ProTek Devices, based in Tempe, Arizona USA, is a manufacturer of Transient Voltage Suppression (TVS) products designed specifically for the protection of electronic systems from the effects of lightning, Electrostatic Discharge (ESD), Nuclear Electromagnetic Pulse (NEMP), inductive switching and EMI/RFI. With over 25 years of engineering and manufacturing experience, ProTek designs TVS devices that provide application specific protection solutions for all electronic equipment/systems.

ProTek Devices Analog Products Division, also manufactures analog interface, control, RF and power management products.

CONTACT US

Corporate Headquarters

2929 South Fair Lane
Tempe, Arizona 85282
USA

By Telephone

General: 602-431-8101
Sales: 602-414-5109
Customer Service: 602-414-5114

By Fax

General: 602-431-2288

By E-mail:

Sales: sales@protekdevices.com
Customer Service: service@protekdevices.com
Technical Support: support@protekdevices.com

Web

www.protekdevices.com
www.protekanalog.com

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